CBCX68 SERIES NPN CBCX69 SERIES PNP

SURFACE MOUNT COMPLEMENTARY SILICON SMALL SIGNAL TRANSISTORS



Central Semiconductor Corp.

www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CBCX68 and CBCX69 series types are complementary silicon transistors manufactured by the epitaxial planar process, epoxy molded in a surface mount package, designed for applications requiring high current capability.

MARKING: FULL PART NUMBER

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Collector-Emitter Voltage	V _{CES}	25	V
Collector-Emitter Voltage	V _{CEO}	20	V
Emitter-Base Voltage	V _{EBO}	5.0	V
Continous Collector Current	۱ _C	1.0	А
Peak Collector Current	ICM	2.0	А
Continuous Base Current	۱ _B	100	mA
Peak Base Current	I _{BM}	200	mA
Power Dissipation	PD	1.2	W
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	104	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _{CBO}	V _{CB} =25V			100	nA
ICBO	V _{CB} =25V, T _A =150°C			10	μA
IEBO	V _{EB} =5.0V			10	μA
BVCBO	Ι _C =10μΑ	25			V
BVCEO	I _C =10mA	20			V
BVEBO	Ι _Ε =10μΑ	5.0			V
V _{CE(SAT)}	I _C =1.0A, I _B =100mA			0.5	V
V _{BE(ON)}	V _{CE} =10V, I _C =5.0mA		0.6		V
V _{BE(ON)}	V _{CE} =1.0V, I _C =1.0A			1.0	V
h _{FE}	V _{CE} =10V, I _C =5.0mA	50			
h _{FE}	V _{CE} =1.0V, I _C =500mA (CBCX68, CBCX69)	85		375	
h _{FE}	V _{CE} =1.0V, I _C =500mA (CBCX68-16, CBCX69-16)	100		250	
h _{FE}	V _{CE} =1.0V, I _C =500mA (CBCX68-25, CBCX69-25)	160		400	
h _{FE}	V _{CE} =1.0V, I _C =1.0A	60			
fT	V _{CE} =5.0V, I _C =10mA, f=20MHz	65			MHz

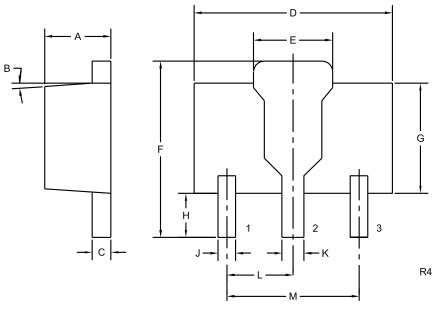
R11 (23-February 2012)



CBCX68 SERIES NPN CBCX69 SERIES PNP

SURFACE MOUNT COMPLEMENTARY SILICON SMALL SIGNAL TRANSISTORS

SOT-89 CASE - MECHANICAL OUTLINE



(BOTTOM VIEW)

LEAD CODE:
1) EMITTER
2) COLLECTOR
3) BASE

MARKING: FULL PART NUMBER

DIMENSIONS						
	INCHES		MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX		
A	0.055	0.067	1.40	1.70		
В	4°		4°			
С	0.014	0.018	0.35	0.46		
D	0.173	0.185	4.40	4.70		
E	0.064	0.074	1.62	1.87		
F	0.146	0.177	3.70	4.50		
G	0.090	0.106	2.29	2.70		
Н	0.028	0.051	0.70	1.30		
J	0.014	0.019	0.36	0.48		
K	0.017	0.023	0.44	0.58		
Ĺ	0.059		1.50			
М	0.118		3.00			
SOT-89 (REV: R4)						

R11 (23-February 2012)

www.centralsemi.com

OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- · Environmental regulation compliance
- Customer specific screening
- · Up-screening capabilities

· Custom product packing

Custom bar coding for shipments

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when 1. ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA Main Tel: (631) 435-1110 Main Fax: (631) 435-1824 Support Team Fax: (631) 435-3388 www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

Worldwide Distributors: www.centralsemi.com/wwdistributors

For the latest version of Central Semiconductor's LIMITATIONS AND DAMAGES DISCLAIMER. which is part of Central's Standard Terms and Conditions of sale, visit: www.centralsemi.com/terms

